L Number	Hits	Search Text	DB	Time stamp
L Number	1	5925259.pn.	USPAT;	2003/01/02 10:11
1	1	5325253.pir.	US-PGPUB	2003/01/02 10:11
-	1	4041114.pn.	USPAT;	2003/01/02 10:11
_	1	5521030.pn.	US-PGPUB USPAT;	2002/08/20 09:46
_	1	4041114.pn.	US-PGPUB USPAT;	2002/08/28 10:59
	534	stamp and lithograph\$2	US-PGPUB USPAT;	2002/08/30 10:34
			US-PGPUB	2002/08/28 11:53
-	29	stamp and lithograph\$2 and nano	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/28 11:53
_	577	stamp and lithograph\$2	USPAT; US-PGPUB; EPO; JPO;	2002/08/28 14:31
	1	"4443408".PN.	DERWENT USPAT	2002/08/28 12:23
-	41085	IBM.as.	USPAT;	2002/08/28 14:33
			US-PGPUB; EPO; JPO;	
_	149	IBM.as. and (stamp or indent\$5 or	DERWENT USPAT;	2002/08/28 14:45
		emboss\$3)	US-PGPUB; EPO; JPO;	
		5501030	DERWENT	2002/08/28 14:48
_	2	5521030.pn.	USPAT; US-PGPUB;	2002/00/20 14:48
			EPO; JPO; DERWENT	
-	6843	kumar.in.	USPAT; US-PGPUB;	2002/08/28 15:22
			EPO; JPO;	
_	154	microcontact adj printing	DERWENT USPAT; US-PGPUB;	2002/08/28 15:02
			EPO; JPO; DERWENT; IBM_TDB	
-	115	(microcontact adj printing) not (stamp and lithograph\$2)	USPAT; US-PGPUB; EPO; JPO;	2002/08/28 14:52
			DERWENT; IBM_TDB	
-	48	micro adj contact adj printing	USPAT; US-PGPUB; EPO; JPO;	2002/08/28 15:03
			DERWENT; IBM TDB	
_	36	(micro adj contact adj printing) not	USPAT; US-PGPUB;	2002/08/28 15:03
		((microcontact adj printing) not (stamp and lithograph\$2))	EPO; JPO;	
			DERWENT; IBM_TDB	
-	46	kumar.in. and amit	USPAT; US-PGPUB;	2002/08/28 15:23
			EPO; JPO; DERWENT	
-	590	rubber adj stamp	USPAT; US-PGPUB	2002/08/28 16:10
_	659	(rubber or elastomer\$2) adj stamp	USPAT;	2002/08/28 17:04
_	1	5772905.pn.	US-PGPUB USPAT;	2002/08/28 17:06
_	1	6365059.pn.	US-PGPUB USPAT;	2002/08/28 17:06
			US-PGPUB USPAT;	2002/08/30 09:18
-	1	3772303.pm.	US-PGPUB	

-	536	stamp and lithograph\$2	USPAT;	2002/08/30 10:34
			US-PGPUB	
-	19	(stamp and lithograph\$2 ) and (conducting	USPAT;	2002/08/30 10:35
		adj polymer)	US-PGPUB	
-	1	5900160.pn.	USPAT;	2002/08/30 14:48
			US-PGPUB	
-	1	5772905.pn.	USPAT;	2002/08/31 13:05
			US-PGPUB	
-	1111	(clean\$4 near4 liquid) and chamber and	USPAT;	2002/12/31 17:52
:		semiconductor	US-PGPUB	
-	294		USPAT;	2002/12/31 18:04
		semiconductor) and @ad<19950720	US-PGPUB	2000/40/20 10 10
-	57		USPAT;	2002/12/31 18:13
		semiconductor) and @ad<19950720) and	US-PGPUB	
1		(clean\$4 near7 etch\$4)		2000/10/21 10:12
-	30		USPAT;	2002/12/31 18:13
[		semiconductor) and @ad<19950720) and	US-PGPUB	
		(clean\$4 near7 etch\$4)) and (clean\$4 near7		
		chamber)		<u>                                     </u>